**Application No.: 10/531,391** 

IN THE CLAIMS

Please amend the claims as follows:

1. (Currently Amended) A semiconductor laser device, comprising:

a semiconductor laser element arranged inside an airtight-sealed package, the

semiconductor laser element having an active region formed of a gallium nitride-based crystal,

wherein a rated output power of the semiconductor laser device is 30 mW or more, and

an atmospheric gas inside the package is a mixture of oxygen and nitrogen, with an oxygen

content of more than 20%, and the semiconductor laser device has a mean time to failure

(MTTF) of 3,000 hours or more at 70°C.

2. (Original) The semiconductor laser device of claim 1, wherein the semiconductor laser

element has a dielectric oxide film formed on a laser emission surface thereof.

3. (Cancelled)

4. (Original) The semiconductor laser device of claim 1, wherein the semiconductor

laser element emits light having a wavelength of 0.9 µm or less.

5. (Previously Presented) The semiconductor laser device of claim 1,

wherein the atmospheric gas inside the package is dry air.

6. (Cancelled)

2

## **Application No.: 10/531,391**

- 7. (Cancelled)
- 8. (Cancelled)
- 9. (Previously Presented) The semiconductor laser device of claim 1, wherein the gallium nitride-based crystal is an AlGaN- or InGaN-based crystal.